



SEMITRANS® 3

Trench IGBT Modules

SKM 200GB126D

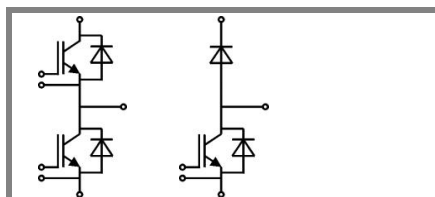
SKM 200GAL126D

Features

- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability, self limiting to $6 \times I_C$

Typical Applications

- Electronic welders
- AC inverter drives
- UPS



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Absolute Maximum Ratings		$T_{case} = 25^\circ C$, unless otherwise specified			
Symbol	Conditions	Values		Units	
IGBT					
V_{CES}	$T_j = 25^\circ C$	1200		V	
I_C	$T_j = 150^\circ C$	$T_c = 25^\circ C$	260		A
		$T_c = 80^\circ C$	190		A
I_{CRM}	$I_{CRM} = 2 \times I_{Cnom}$	300		A	
V_{GES}		± 20		V	
t_{psc}	$V_{CC} = 600 V$; $V_{GE} \leq 20 V$; $T_j = 125^\circ C$ $V_{CES} < 1200 V$	10		μs	
Inverse Diode					
I_F	$T_j = 150^\circ C$	$T_c = 25^\circ C$	200		A
		$T_c = 80^\circ C$	140		A
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$	300		A	
I_{FSM}	$t_p = 10 ms$; sin.	$T_j = 150^\circ C$	1100		A
Freewheeling Diode					
I_F	$T_j = 150^\circ C$	$T_{case} = 25^\circ C$	200		A
		$T_{case} = 80^\circ C$	140		A
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$; $t_p = 1 ms$	300		A	
I_{FSM}	$t_p = 10 ms$; sin.	$T_j = 150^\circ C$	1100		A
Module					
$I_{t(RMS)}$		500		A	
T_{vj}		- 40 ... + 150		$^\circ C$	
T_{stg}		- 40 ... + 125		$^\circ C$	
V_{isol}	AC, 1 min.	4000		V	

Characteristics		$T_{case} = 25^\circ C$, unless otherwise specified				
Symbol	Conditions	min.	typ.	max.	Units	
IGBT						
$V_{GE(th)}$	$V_{GE} = V_{CE}$; $I_C = 6 mA$	5	5,8	6,5	V	
I_{CES}	$V_{GE} = 0 V$; $V_{CE} = V_{CES}$	$T_j = 25^\circ C$	0,1		0,3	mA
		$T_j = 125^\circ C$				mA
V_{CE0}		$T_j = 25^\circ C$	1		1,2	V
		$T_j = 125^\circ C$	0,9		1,1	V
r_{CE}	$V_{GE} = 15 V$	$T_j = 25^\circ C$	4,7		6,3	m Ω
		$T_j = 125^\circ C$	7,3		9	m Ω
$V_{CE(sat)}$	$I_{Cnom} = 150 A$; $V_{GE} = 15 V$	$T_j = 25^\circ C_{chiplev.}$	1,7		2,15	V
		$T_j = 125^\circ C_{chiplev.}$	2		2,45	V
C_{ies}	$V_{CE} = 25$; $V_{GE} = 0 V$	$f = 1 MHz$	10,8		nF	
C_{oes}			0,9		nF	
C_{res}			0,9		nF	
Q_G	$V_{GE} = -8V - +20V$	1530		nC		
R_{Gint}	$T_j = 25^\circ C$	5		Ω		
$t_{d(on)}$	$R_{Gon} = 1,5 \Omega$	$V_{CC} = 600V$ $I_{Cnom} = 150A$	260		ns	
t_r			40		ns	
E_{on}	$R_{Goff} = 1,5 \Omega$	$T_j = 125^\circ C$ $V_{GE} = \pm 15V$	18		mJ	
$t_{d(off)}$			540		ns	
t_f			110		ns	
E_{off}					mJ	
$R_{th(j-c)}$	per IGBT			0,13	K/W	



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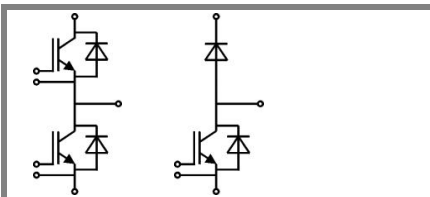
Typical Applications

- Electronic welders
- AC inverter drives
- UPS

Characteristics					
Symbol	Conditions	min.	typ.	max.	Units
Inverse diode					
$V_F = V_{EC}$	$I_{Fnom} = 150 \text{ A}; V_{GE} = 0 \text{ V}$	$T_j = 25 \text{ }^\circ\text{C}_{chiplev.}$	1,6	1,8	V
		$T_j = 125 \text{ }^\circ\text{C}_{chiplev.}$	1,6	1,8	V
V_{F0}		$T_j = 25 \text{ }^\circ\text{C}$	1	1,1	V
		$T_j = 125 \text{ }^\circ\text{C}$	0,8	0,9	V
r_F		$T_j = 25 \text{ }^\circ\text{C}$	4	4,7	mΩ
		$T_j = 125 \text{ }^\circ\text{C}$	5,3	6	mΩ
I_{RRM}	$I_{Fnom} = 150 \text{ A}$	$T_j = 125 \text{ }^\circ\text{C}$	240		A
Q_{rr}	$di/dt = 5000 \text{ A}/\mu\text{s}$		42		μC
E_{off}	$V_{GE} = -15 \text{ V}; V_{CC} = 600 \text{ V}$				mJ
$R_{th(j-c)D}$	per diode			0,3	K/W
FWD					
$V_F = V_{EC}$	$I_{Fnom} = 150 \text{ A}; V_{GE} = 0 \text{ V}$	$T_j = 25 \text{ }^\circ\text{C}_{chiplev.}$	1,6	1,8	V
		$T_j = 125 \text{ }^\circ\text{C}_{chiplev.}$	1,6	1,8	V
V_{F0}		$T_j = 25 \text{ }^\circ\text{C}$	1	1,1	V
		$T_j = 125 \text{ }^\circ\text{C}$	0,8	0,9	V
r_F		$T_j = 25 \text{ }^\circ\text{C}$	4	4,7	V
		$T_j = 125 \text{ }^\circ\text{C}$	5,3	6	V
I_{RRM}	$I_{Fnom} = 150 \text{ A}$	$T_j = 125 \text{ }^\circ\text{C}$	240		A
Q_{rr}	$di/dt = 5000 \text{ A}/\mu\text{s}$		42		μC
E_{off}	$V_{GE} = -15 \text{ V}; V_{CC} = 600 \text{ V}$				mJ
$R_{th(j-c)FD}$	per diode			0,3	K/W
Module					
L_{CE}			15	20	nH
$R_{CC'+EE'}$	res., terminal-chip	$T_{case} = 25 \text{ }^\circ\text{C}$	0,35		mΩ
		$T_{case} = 125 \text{ }^\circ\text{C}$	0,5		mΩ
$R_{th(c-s)}$	per module			0,038	K/W
M_s	to heat sink M6		3	5	Nm
M_t	to terminals M5		2,5	5	Nm
w				325	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.



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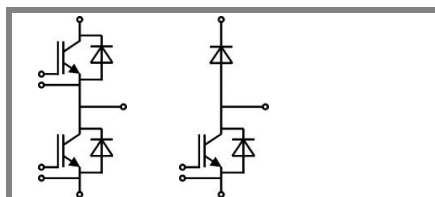
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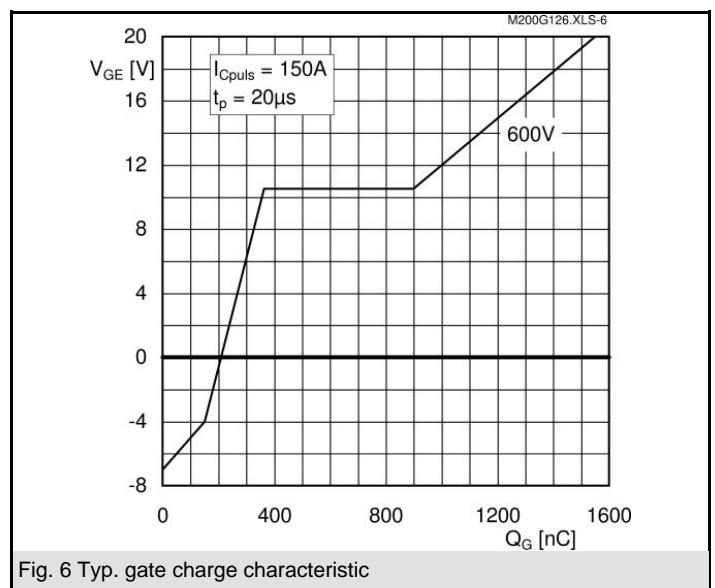
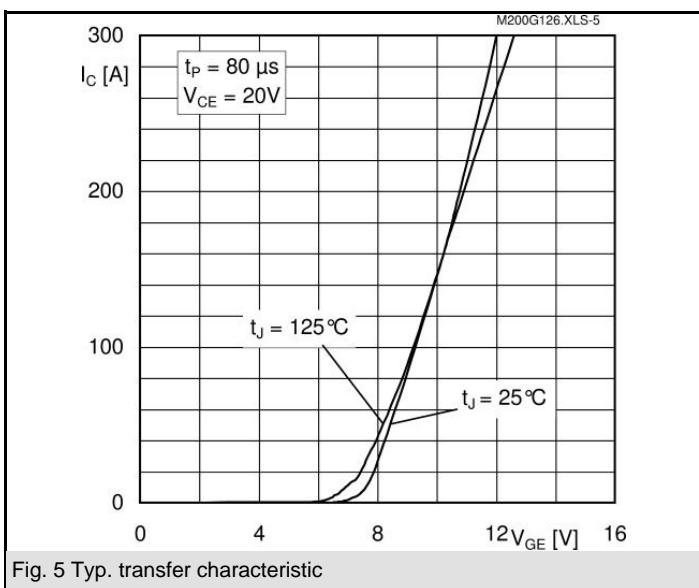
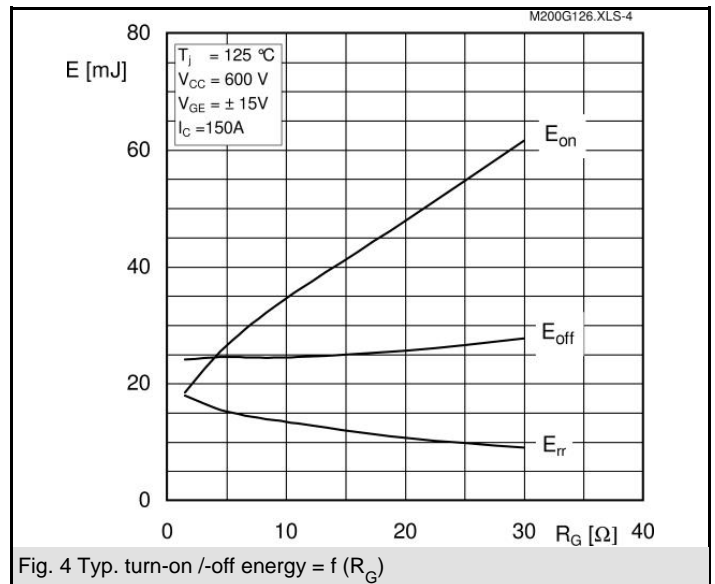
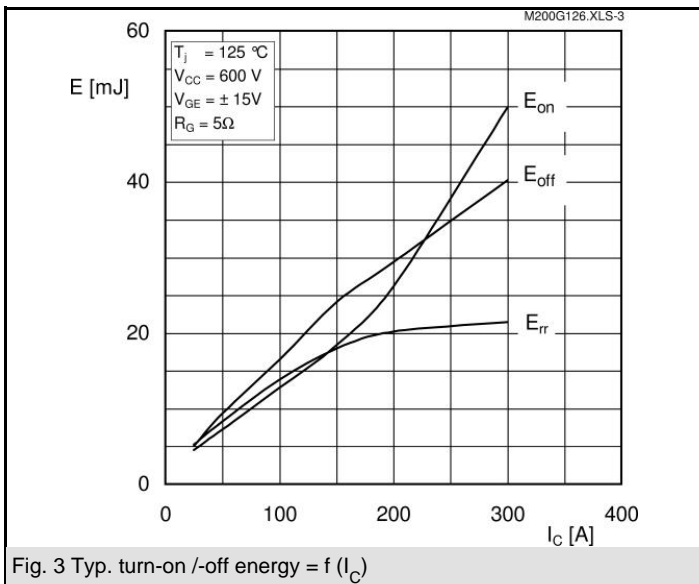
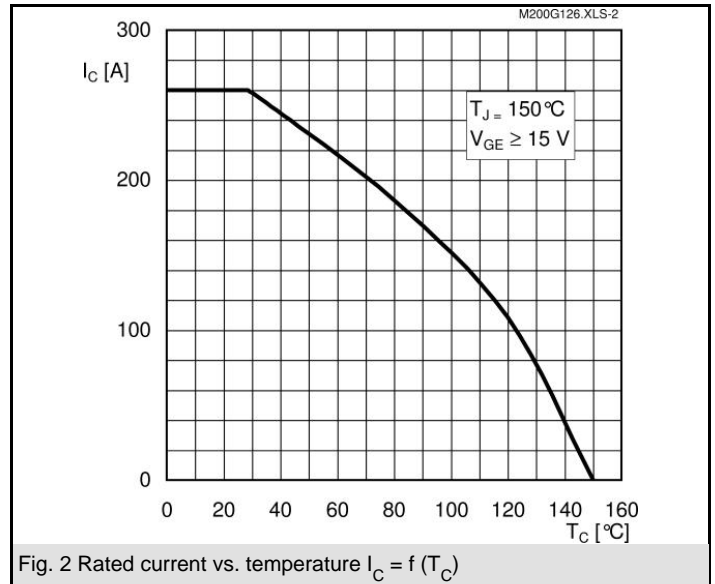
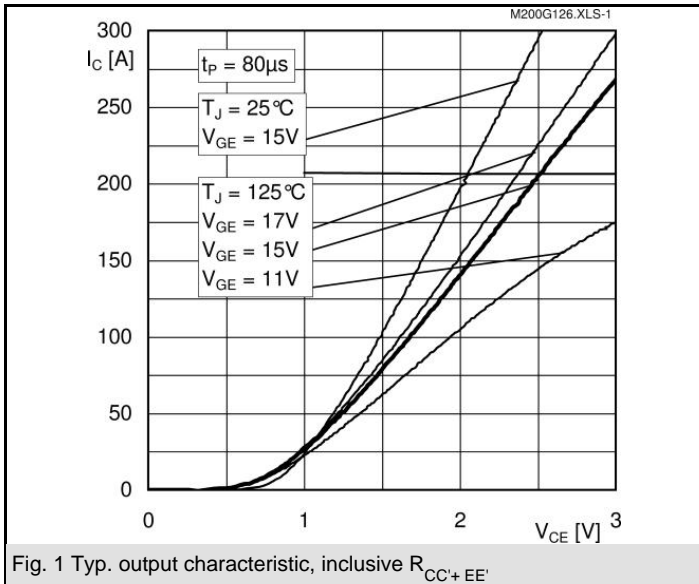
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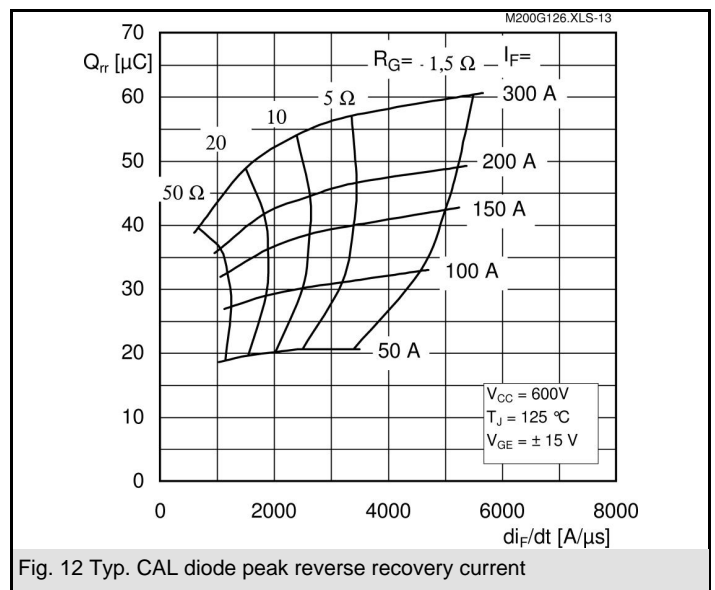
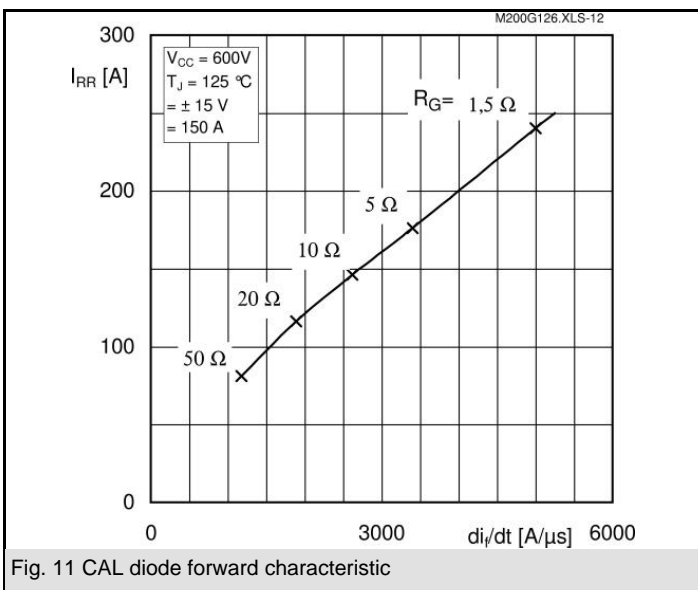
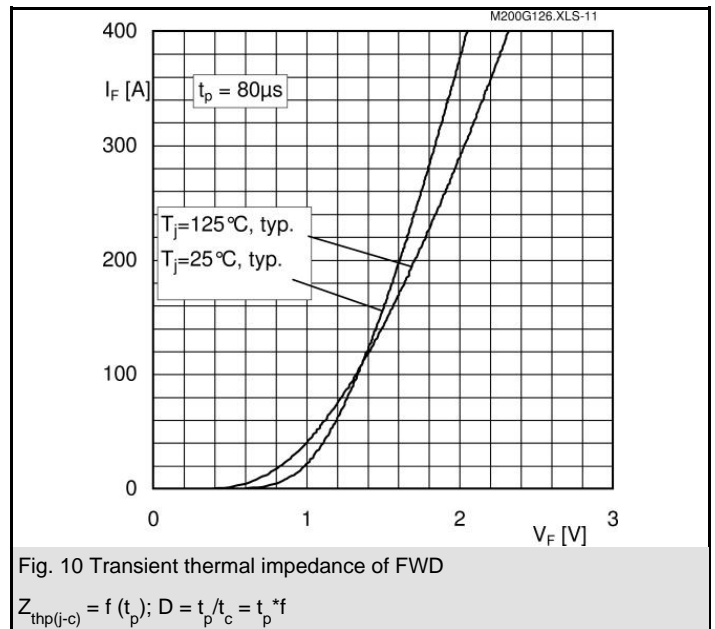
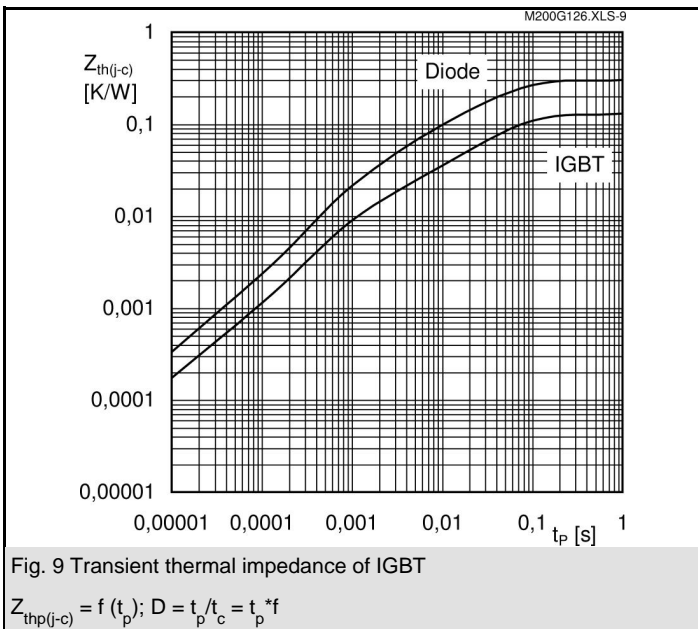
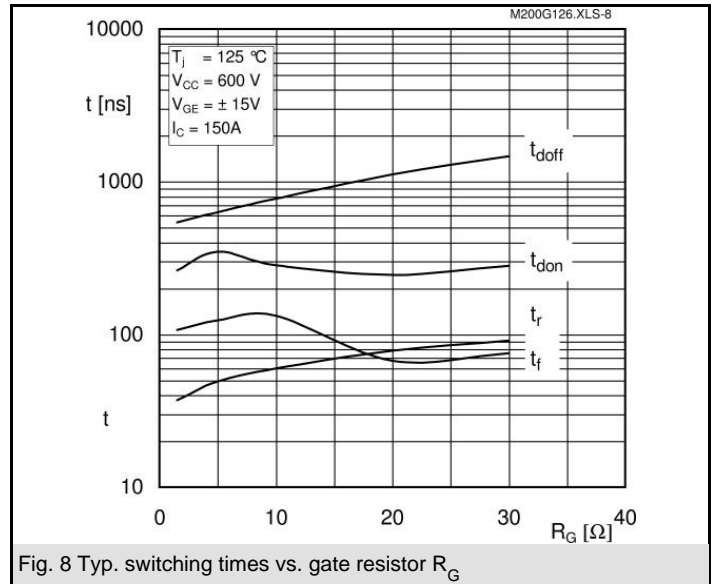
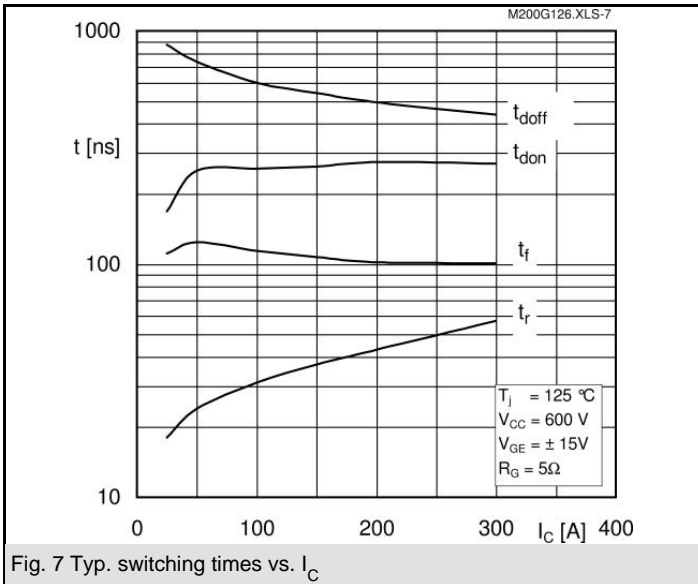
Z_{th}		Symbol	Conditions	Values	Units
$Z_{th(j-c)I}$					
$R_{\theta j-c}$			$i = 1$	95	mk/W
$R_{\theta j-c}$			$i = 2$	27	mk/W
$R_{\theta j-c}$			$i = 3$	6,7	mk/W
$R_{\theta j-c}$			$i = 4$	1,3	mk/W
$\tau_{th(j-c)}$			$i = 1$	0,0744	s
$\tau_{th(j-c)}$			$i = 2$	0,0087	s
$\tau_{th(j-c)}$			$i = 3$	0,002	s
$\tau_{th(j-c)}$			$i = 4$	0,0001	s
$Z_{th(j-c)D}$					
$R_{\theta j-c}$			$i = 1$	200	mk/W
$R_{\theta j-c}$			$i = 2$	80	mk/W
$R_{\theta j-c}$			$i = 3$	17	mk/W
$R_{\theta j-c}$			$i = 4$	3	mk/W
$\tau_{th(j-c)}$			$i = 1$	0,0536	s
$\tau_{th(j-c)}$			$i = 2$	0,0056	s
$\tau_{th(j-c)}$			$i = 3$	0,09	s
$\tau_{th(j-c)}$			$i = 4$	0,0002	s



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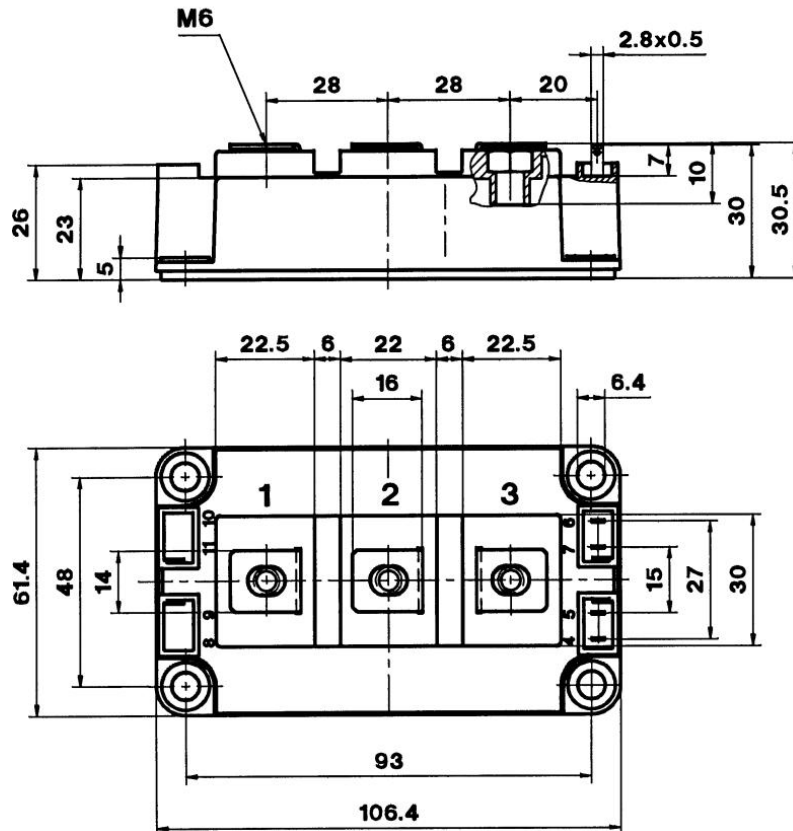


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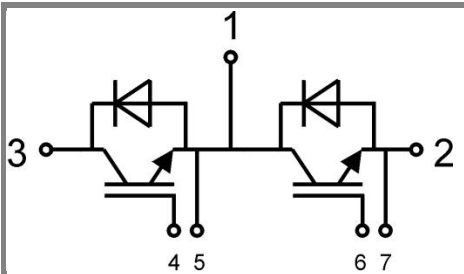
UL Recognized
File no. E 63 532

Dimensions in mm

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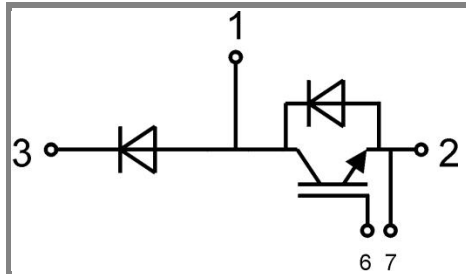


Case D 56



Case D56

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Case D57

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